

Flux varnish LT4

The product protects the printed circuit boards against oxidation and corrosion during storage. This allows for faster soldering and prevents from „cold solders”. The application method enables easy distribution of the product on boards. It can be used during production, repair, maintenance and service. It meets the requirements of ISO 9454 typ 1111 / J-STD-004 ROL0.

Flux type: rosin
Type of flux: RMA

Physicochemical properties	
Physical state	gas
Color	amber color
Density at 20° C	0,8 ± 0,1 g/cm ³
Viscosity at 20° C	23,1 cP
Drying time	20 - 30 min

Application:

- protection of PCB against oxidation,
- applied in the production of printed circuit boards immediately after etching,
- prevents from contamination during assembly,
- it allows for easier soldering of heavily oxidized surfaces.

Packagings:

Volume	Type of packaging	Collective packaging	Item Code
100ml	aerosol	4/20	ART.AGT-235

Warehousing:

Warehouse in closed containers in a dry, well-ventilated place, away from heat and ignition sources and direct sunlight. Do not expose to temperatures exceeding 50°C/ 122°F. Protect against electrostatic discharges.

Data contained in this document are consistent with the current state of our knowledge. They describe typical product properties and applications. However, it is up to the user to examine the suitability of this product for specific applications. We deny liability for the obtained results on the grounds that application conditions lie beyond our control.